



Ai-WB3-01C Specification

Version V1.0.0

Copyright ©2023

Document resume

Content

| | |
|--|----|
| 1. Product Overview | 4 |
| 1.1. Characteristic | 5 |
| 2. Main parameters | 6 |
| 2.1. Static electricity requirement | 6 |
| 2.2. Electrical characteristics | 6 |
| 2.3. Wi-Fi RF Performance | 7 |
| 2.4. BLE RF Performance | 7 |
| 2.5. Power | 8 |
| 3. Appearance Dimensions | 9 |
| 4. Pin Definition | 10 |
| 5. Schematic | 12 |
| 6. Antenna parameters | 13 |
| 6.1. Schematic diagram of the antenna test prototype | 13 |
| 6.2. Antenna S parameter | 14 |
| 6.3. Antenna Gain and Efficiency | 14 |
| 6.4. Antenna pattern | 15 |
| 7. Design Guidance | 16 |
| 7.1. Application Guide Circuit | 16 |
| 7.2. Recommend PCB footprint size | 17 |
| 7.3. Antenna layout requirements | 17 |
| 7.4. Power supply | 18 |
| 7.5. GPIO | 19 |
| 8. Storage conditions | 20 |
| 9. Reflow welding curve diagram | 20 |
| 10. Product Packaging Information | 21 |
| 11. Contact us | 21 |
| Disclaimer and copyright notice | 22 |
| Notice | 22 |

1. Product Overview

Ai-WB3-01C is a Wi-Fi&BLE module developed by Shenzhen Ai-Thinker Technology Co., Ltd. The module is equipped with LN882H chip as the core processor and supports Wi-Fi 802.11b/g/n protocol and BLE 5.1 protocol. The LN882H chip integrates the Cortex-M4F core, with a maximum frequency of 160MHz, built-in 296KB SRAM, 128KB ROM and rich peripheral interfaces, including SDIO/SPI/UART/I2C/PWM/ADC/DMA/SWD/GPIO, etc. It can be widely used in Internet of Things (IoT), mobile devices, wearable electronic devices, smart home and other fields.

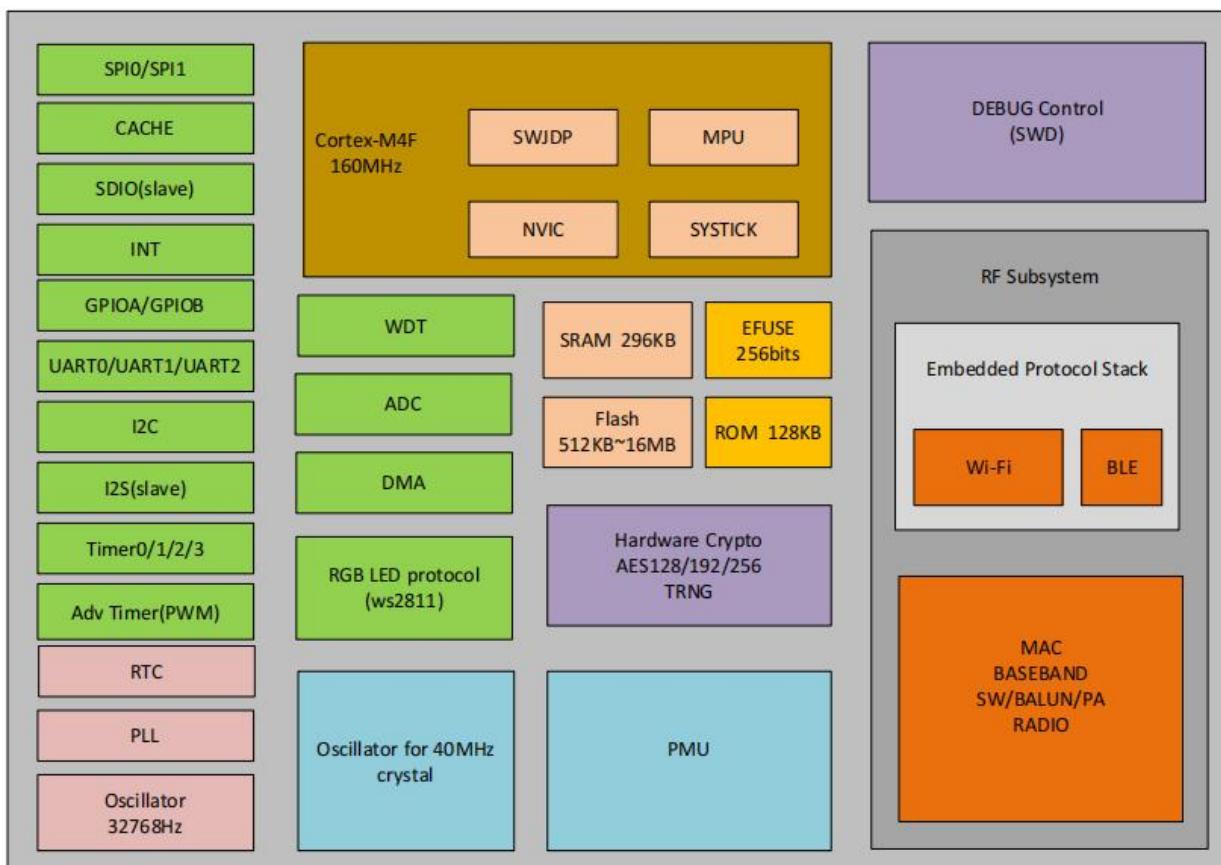


Figure 1 Main chip architecture diagram

1.1. Characteristic

- Package: SMD-21
- Support IEEE 802.11 b/g/n protocol
- Support BLE5.1
- Support long range (125Kbps, 500Kbps) and high data rate (2Mbps)
- Support 296KB SRAM / 128KB ROM
- Support SDIO/SPI/UART/I2C/PWM/ADC/DMA/SWD/GPIO port
- Support multi-channel ADC and programmable amplifier for sound sensors
- Support RTC real-time clock and WDT watchdog
- Supports True Random Number Generator (TRNG)
- Support AES-128\AES-192\AES-256 hardware encryption
- Support 256 bits EFUSE
- Integrated CHKSUM accelerator to improve TCP/UDP transmission

2. Main parameters

Table 1 Description of the main parameters

| | |
|------------------------------|--|
| Model | Ai-WB3-01C |
| Package | SMD-21 |
| Size | 20.3*15.8*3.1(±0.2)mm |
| Antenna | on-board PCB antenna |
| Frequency | 2400 ~ 2483.5MHz |
| Operating temperature | -40°C ~ 85°C |
| Storage temperature | -40°C ~ 125°C, < 90%RH |
| Power supply | Support voltage 2.7V ~ 3.6V, supply current ≥500mA |
| Interface | SDIO/SPI/UART/I2C/PWM/ADC/DMA/SWD/GPIO |
| IO | 18 |
| UART rate | Default 115200 bps |
| Security | AES-128\AES-192\AES-256 Hardware Encryption |
| Flash | Default 2MByte |

2.1. Static electricity requirement

Ai-WB3-01C is an electrostatic sensitive device. Therefore, you need to take special precautions when carrying it.



Figure 2 ESD preventive measures

2.2. Electrical characteristics

Table 2 Electrical characteristics table

| Parameters | Conditio | Min. | Typical value | Max. | Unit |
|----------------|----------|------|---------------|------|------|
| Voltage Supply | VDD | 2.7 | 3.3 | 3.6 | V |
| I/O | VIL | - | -0.3 | 0 | V |
| | VIH | - | VIO-0.6 | VIO | V |
| | VOL | - | -0.45 | 0 | V |
| | VOH | - | VIO-0.5 | VIO | V |

2.3. Wi-Fi RF Performance

Table 3 Wi-Fi RF performance table

| Description | Typical value | | | Unit |
|--------------------------------|------------------|---------------|------|------|
| Frequency range | 2400 ~ 2483.5MHz | | | MHz |
| Output Power | | | | |
| Mode | Min. | Typical value | Max. | Unit |
| 11n Mode HT20, PA output power | - | 14 | - | dBm |
| 11g Mode, PA output power | - | 16 | - | dBm |
| 11b Mode, PA output power | - | 18 | - | dBm |
| Receive Sensitivity | | | | |
| Mode | Min. | Typical | Max. | Unit |
| 11b, 1 Mbps | - | -95 | - | dBm |
| 11b, 11 Mbps | - | -88 | - | dBm |
| 11g, 6 Mbps | - | -91 | - | dBm |
| 11g, 54 Mbps | - | -74 | - | dBm |
| 11n, HT20 (MCS7) | - | -71 | - | dBm |

2.4. BLE RF Performance

Table 4 BLE RF performance table

| Description | Typical value | | | Unit |
|----------------------------|------------------|---------------|------|------|
| Frequency range | 2400 ~ 2483.5MHz | | | MHz |
| Output Power | | | | |
| Rate Mode | Min. | Typical value | Max. | Unit |
| 1Mbps | - | 10 | - | dBm |
| Receive Sensitivity | | | | |
| Rate Mode | Min. | Typical value | Max. | Unit |
| 1Mbps sensitivity@30.8%PER | - | -94 | - | dBm |

2.5. Power

The following power consumption data is based on a 3.3V power supply and an ambient temperature of 25° C.

- All POUT power for all emission modes is measured at the antenna interface.
- All emission data is based on 95% of the duty ratio, measured in continuous emission mode.

Table 5 Power consumption

| Mode | Min. | AVG | Max. | Unit |
|-------------------------------------|--------|-----|------|------|
| Tx 802.11b, 11Mbps, POUT=+18dBm | - | 260 | - | mA |
| Tx 802.11g, 54Mbps, POUT =+16dBm | - | 247 | - | mA |
| Tx 802.11n, MCS7, POUT =+14dBm | - | 245 | - | mA |
| Rx 802.11b, packet length 1024 byte | - | 90 | - | mA |
| Rx 802.11g, packet length 1024 byte | - | 90 | - | mA |
| Rx 802.11n, packet length 1024 byte | - | 90 | - | mA |
| Sleep Mode | DTIM=1 | - | 11 | mA |
| | DTIM=3 | - | 8 | mA |

3. Appearance Dimensions

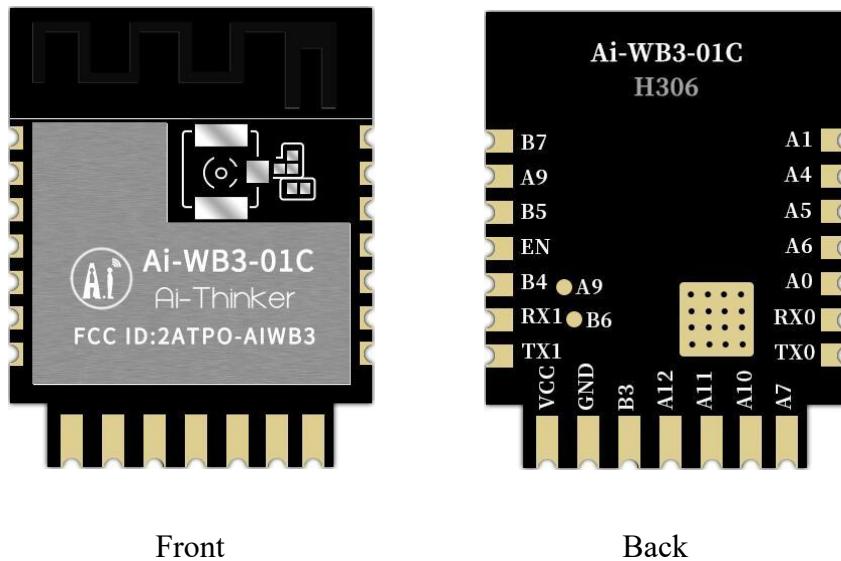


Figure 3 Appearance (the rendering is for reference only, the actual object shall prevail)

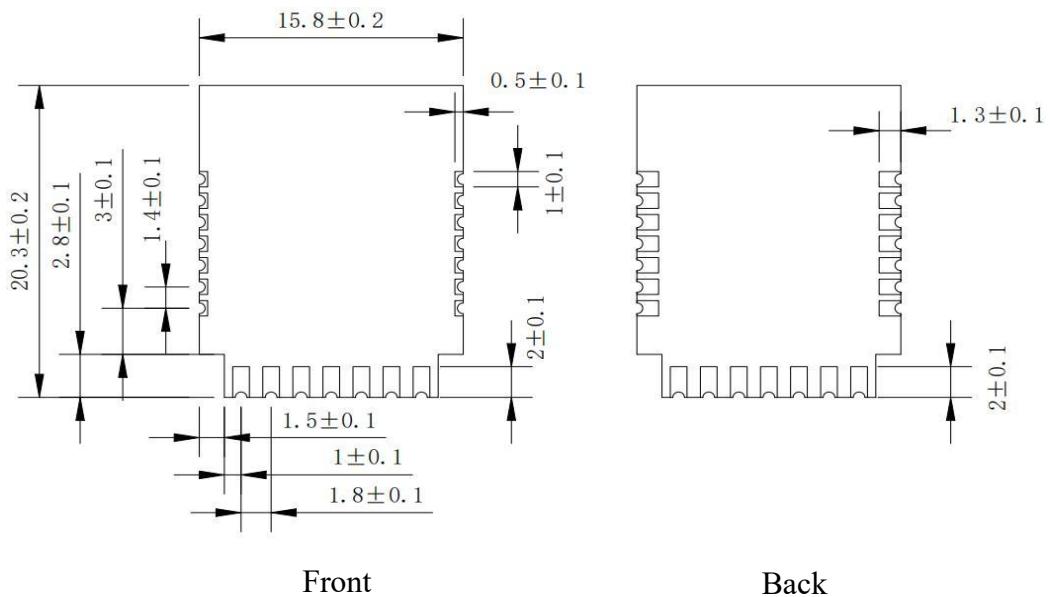


Figure 4 Dimension diagram (unit: mm)

4. Pin Definition

The Ai-WB3-01C module has a total of 21 pins connected, such as the pin schematic diagram, and the pin function definition table is the interface definition.

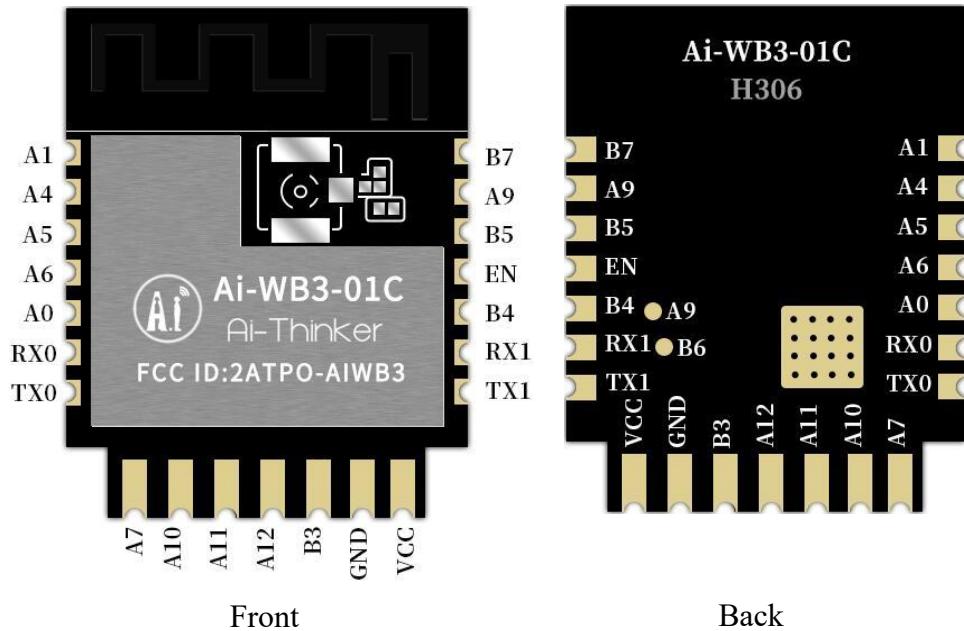


Figure 5 pin diagram

Table 6 Pin function definition table

| No. | Name | Function Description |
|-----|---------------------|---|
| 1 | A1 | GPIOA1/ADC/SWD/EXT_INT/FULLMUX |
| 2 | A4 | GPIOA4/ADC/SWCK/FULLMUX |
| 3 | A5 | GPIOA5/EXT_INT/FULLMUX |
| 4 | A6 | GPIOA6/SDIO_IO2/I2S_SDI/EXT_INT/FULLMUX |
| 5 | A0 | GPIOA0/ADC/EXT_INT/FULLMUX |
| 6 | RX0 | RXD(GPIOA3/EXT_INT/FULLMUX |
| 7 | TX0 | TXD(GPIOA2/EXT_INT/FULLMUX |
| 8 | A7 | GPIOA7/SDIO_IO3/EXT_INT/FULLMUX |
| 9 | A10 | GPIOA10/SDIO_IO0/I2S_SDO/FULLMUX |
| 10 | A11 | GPIOA11/SDIO_IO1/FULLMUX |
| 11 | A12 | GPIOA12/FULLMUX |
| 12 | B3 | GPIOB3/ADC/FULLMUX |
| 13 | GND | Ground |
| 14 | VCC | 3.3V power supply, the output current of the external power supply is recommended to be above 500mA |
| 15 | TX1 | TXD(GPIOB9/FULLMUX/EXT_INT |
| 16 | RX1 | RXD(GPIOB8/FULLMUX |
| 17 | B4 | GPIOB4/ADC/FULLMUX |
| 18 | EN | Default as chip enable, active high |
| 19 | B5 | GPIOB5/ADC/FULLMUX |
| 20 | A9 | GPIOA9/SDIO_CLK/I2S_SCLK/FLLMUX/BOOT_MODE |
| 21 | B7 | GPIOB7/FULLMUX |
| 22 | Measurement point 1 | GPIOA9/SDIO_CLK/I2S_SCLK/FLLMUX/BOOT_MODE |
| 23 | Measurement point 2 | GPIOB6/FULLMUX |

Note: 1. IOA9 is used as Bootstrap. When the power is low at the moment of power-on, the module enters the programming mode; when the power is high at the moment of power-on, the module starts normally. The module supports 1 master/slave I2C interface and 2 SPI interfaces, and any two pins with FULLMUX characteristics can be configured as I2C and SPI.

5. Schematic

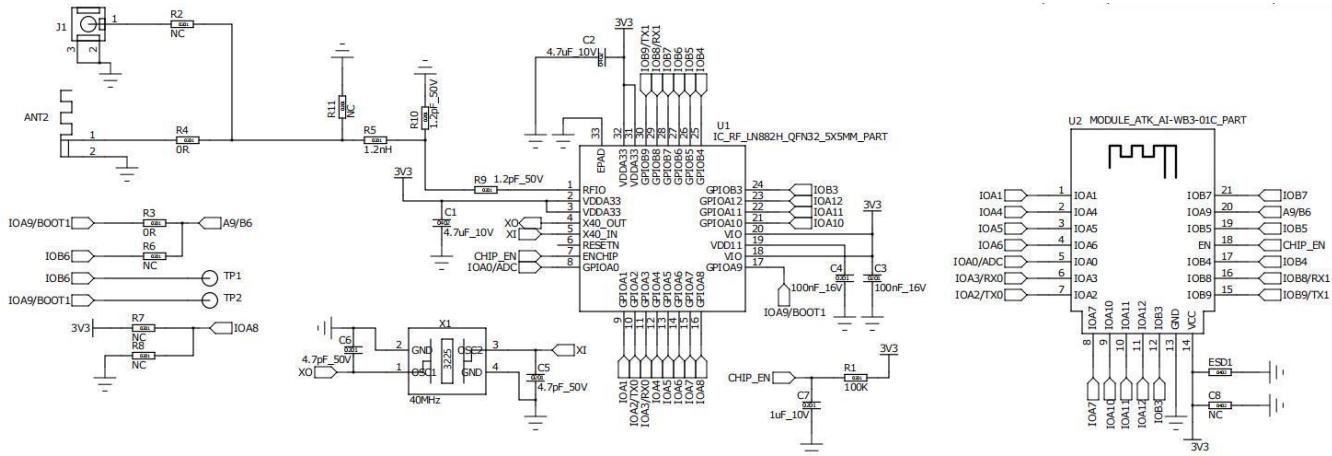


Figure 6 Module schematic

6. Antenna parameters

6.1. Schematic diagram of the antenna test prototype



Figure 7 Schematic diagram of the antenna test prototype

6.2. Antenna S parameter

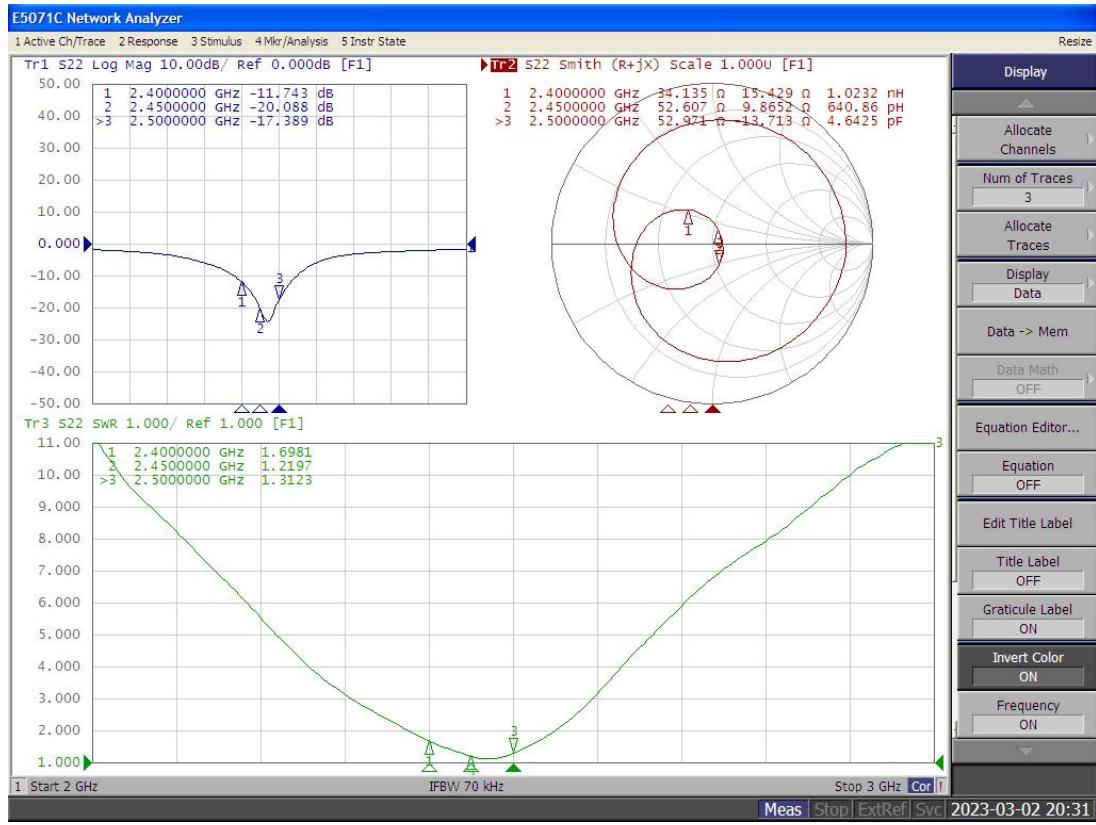


Figure 8 Antenna S parameters

6.3. Antenna Gain and Efficiency

Table 7 Antenna Gain and efficiency

| Frequency ID | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 |
|----------------|------|------|------|------|------|------|------|------|------|------|------|
| Frequency(MHz) | 2400 | 2410 | 2420 | 2430 | 2440 | 2450 | 2460 | 2470 | 2480 | 2490 | 2500 |
| Gain (dBi) | 0.97 | 1.01 | 1.17 | 1.33 | 1.60 | 1.81 | 1.93 | 1.93 | 1.91 | 1.89 | 1.83 |
| Efficiency (%) | 49.1 | 48.8 | 49.4 | 50.7 | 53.7 | 55.2 | 56.4 | 56.3 | 55.7 | 54.4 | 53.5 |

6.4. Antenna pattern

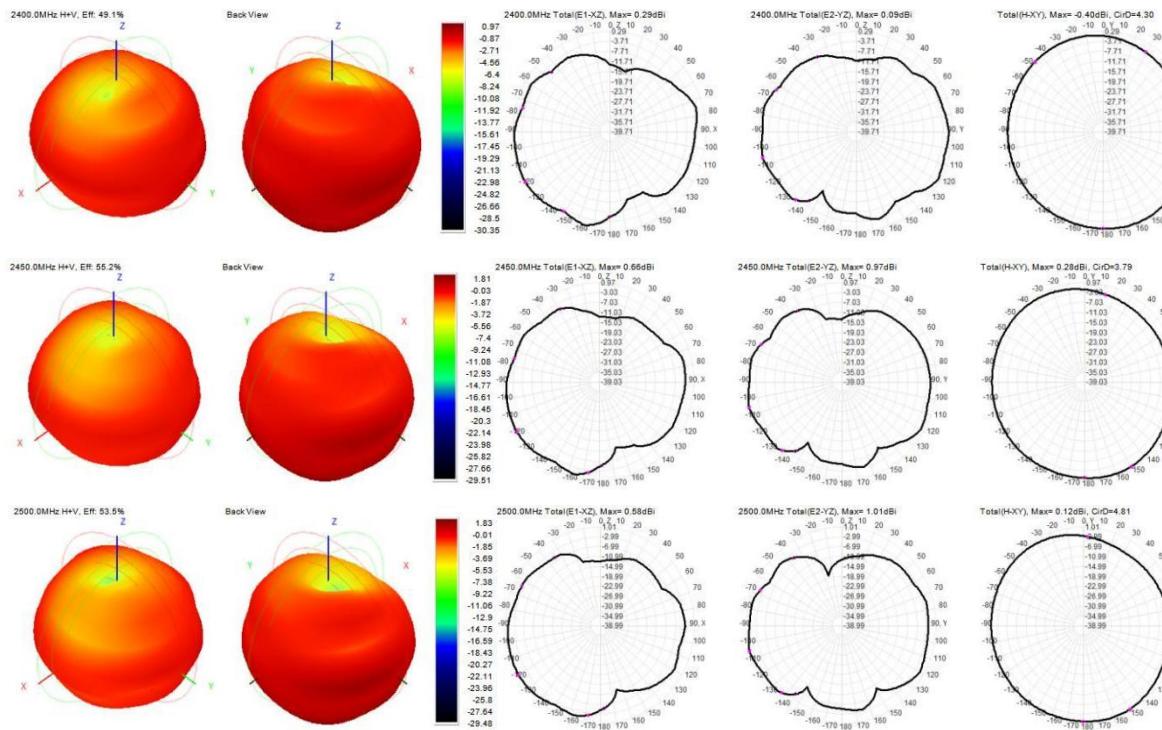


Figure 9 Antenna pattern

7. Design Guidance

7.1. Application Guide Circuit

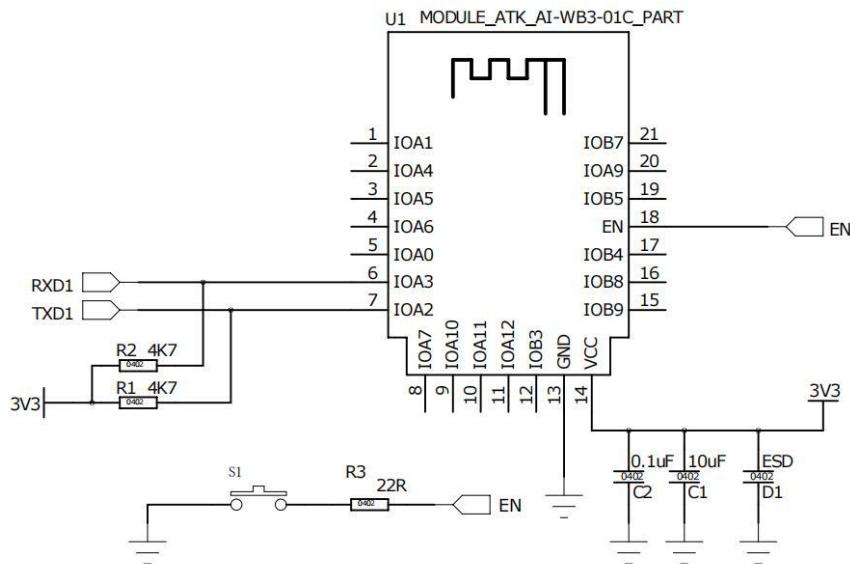


Figure 10 Application circuit diagram

- If the IO port is used as PWM, it is recommended to reserve a 4.7K pull-down resistor around the module. Especially in the application of light control, it can prevent the phenomenon of flashing lights at the moment of power-on and start-up.

7.2. Recommend PCB footprint size

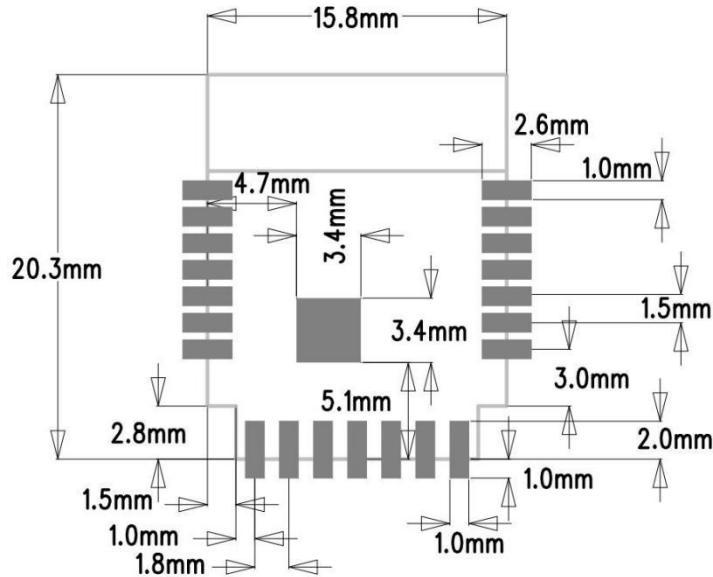


Figure 11 Recommend PCB footprint size(unit:mm)

7.3. Antenna layout requirements

- For the installation position on the motherboard, the following two methods are recommended:

Solution 1: Put the module on the edge of the motherboard, and the antenna area extends out of the edge of the motherboard.

Solution 2: Put the module on the edge of the motherboard, and hollow out an area on the edge of the motherboard where the antenna is.

- In order to meet the performance of the on-board antenna, it is forbidden to place metal parts around the antenna and keep away from high-frequency devices.

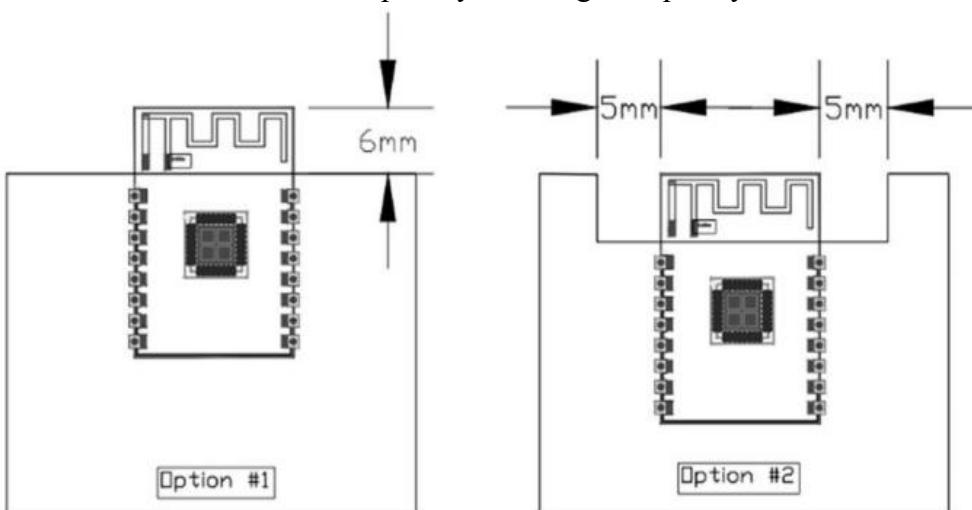


Figure 12 Antenna layout diagram

7.4. Power supply

- Recommend 3.3V voltage, peak current above 500mA.
- It is recommended to use LDO power supply; if using DC-DC, it is recommended to control the ripple within 30mV.
- It is recommended to reserve the position of the dynamic response capacitor for the DC-DC power supply circuit, which can optimize the output ripple when the load changes greatly.
- It is recommended to add ESD devices to the 3.3V power interface

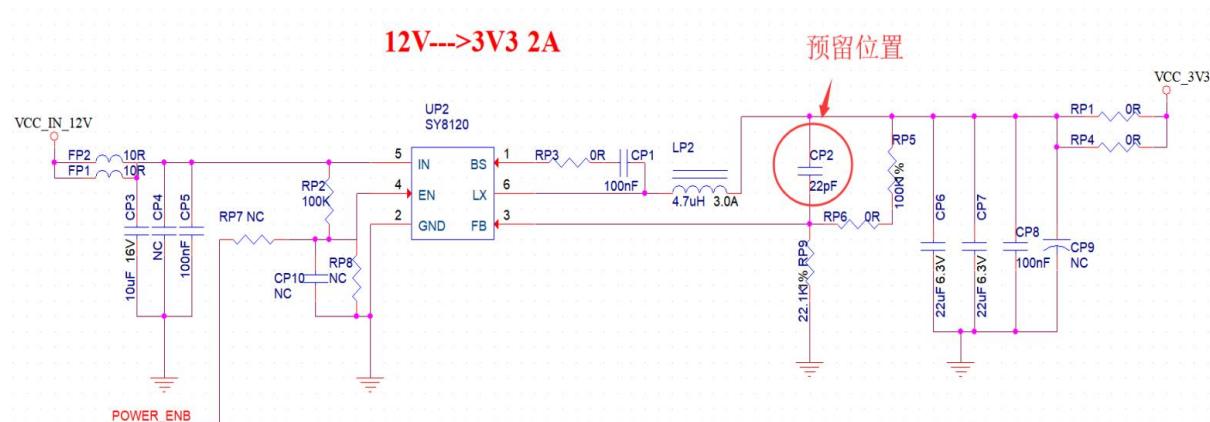


Figure 13 DC-DC step-down circuit diagram

7.5. GPIO

- There are some IO ports on the periphery of the module. If you need to use it, it is recommended to connect a 10-100 ohm resistor in series with the IO ports. This can suppress overshoot and make the levels on both sides more stable. Helpful for both EMI and ESD.
- For the pull-up and pull-down of the special IO port, please refer to the instructions in the specification, which will affect the startup configuration of the module.
- The IO port of the module is 3.3V. If the level of the main control and the IO port of the module do not match, a level conversion circuit needs to be added.
- If the IO port is directly connected to the peripheral interface, or terminals such as pin headers, it is recommended to reserve an ESD device near the IO port wiring near the terminal.

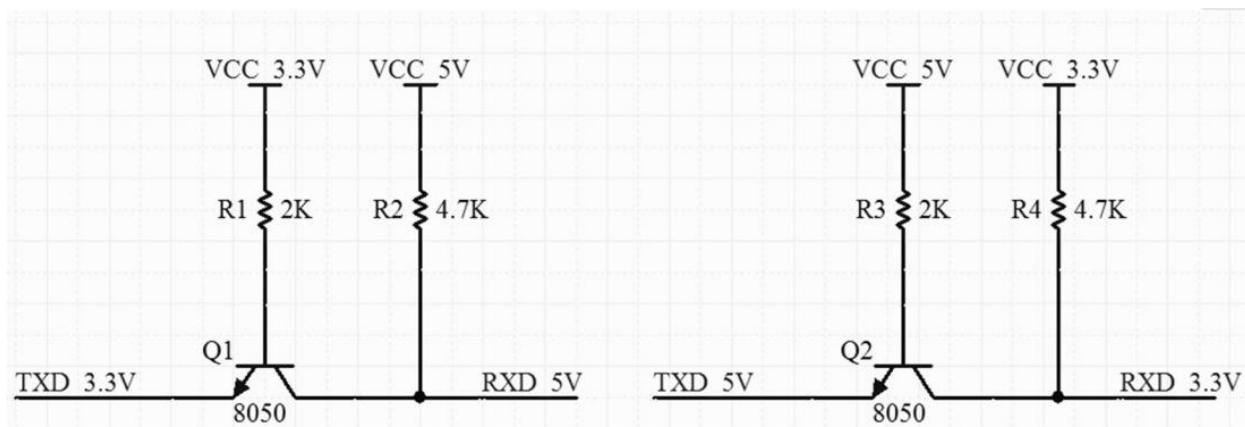


Figure 14 Level convert circuit

8. Storage conditions

Products sealed in moisture-proof bags should be stored in a non-condensing atmosphere at $<40^{\circ}\text{ C}/90\%\text{RH}$.

The moisture sensitivity level MSL of the module is 3.

After the vacuum bag is unpacked, it must be used within 168 hours at $25 \pm 5^{\circ}\text{ C}/60\%\text{RH}$, otherwise it needs to be baked before it can be put online again.

9. Reflow welding curve diagram

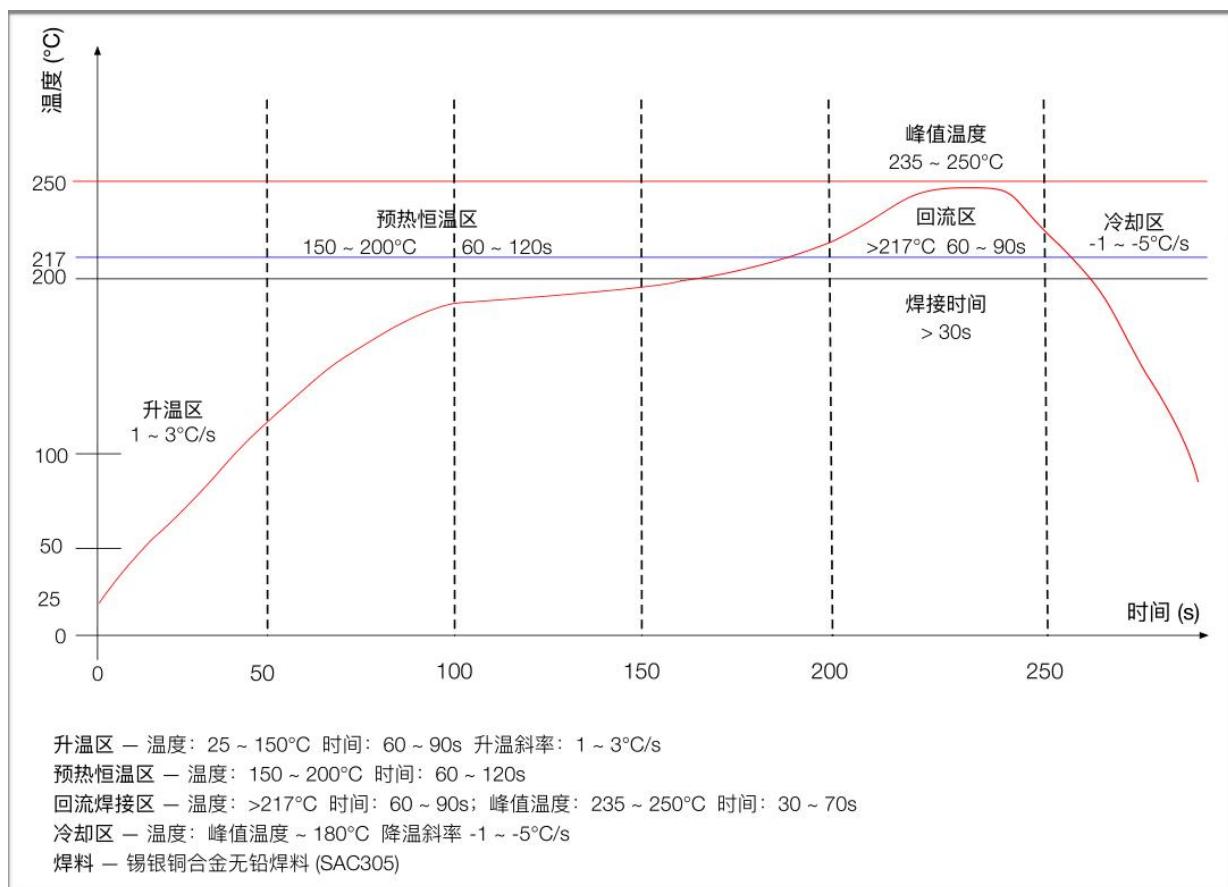


Figure 15 Reflow welding diagram

10. Product Packaging Information

Ai-WB3-01C module was packaged in a tape, 900pcs/reel. As shown in the below image:



Figure 16 Package and packing diagram

11. Contact us

[Ai-Thinker official website](#)

[Office forum](#)

[Develop DOCS](#)

[LinkedIn](#)

[Tmall shop](#)

[Taobao shop](#)

[Alibaba shop](#)

[Technical support email: support@aithinker.com](#)

[Domestic business cooperation: sales@aithinker.com](#)

[Overseas business cooperation: overseas@aithinker.com](#)

Company Address: Room 403,408-410, Block C, Huafeng Smart Innovation Port, Gushu 2nd Road, Xixiang, Baoan District, Shenzhen.

Tel: +86-0755-29162996



WeChat mini program



WeChat official account

Disclaimer and copyright notice

The information in this article,including the URL address for reference,is subject to change without notice.

The document is provided "as is" without any guarantee responsibility,including any guarantee for merchantability,suitability for a specific purpose,or non-infringement,and any guarantee mentioned elsewhere in any proposal,specification or sample.This document does not bear any responsibility,including the responsibility for infringement of any patent rights arising from the use of the information in this document.This document does not grant any license for the use of intellectual property rights in estoppel or other ways,whether express or implied.

The test data obtained in the article are all obtained from Ai-Thinker's laboratory tests, and the actual results may vary slightly.

All brand names,trademarks and registered trademarks mentioned in this article are the property of their respective owners, and it is hereby declared.

The final interpretation right belongs to Shenzhen Ai-Thinker Technology Co.,Ltd.

Notice

Due to product version upgrades or other reasons,the contents of this manual may be changed.

Shenzhen Ai-Thinker Technology Co.,Ltd.reserves the right to modify the contents of this manual without any notice or prompt.

This manual is only used as a guide.Shenzhen Ai-Thinker Technology Co.,Ltd. makes every effort to provide accurate information in this manual.However, Shenzhen Ai-Thinker Technology Co.,Ltd. does not guarantee that the contents of the manual are completely free of errors.All statements and information in this manual And the suggestion does not constitute any express or implied guarantee.